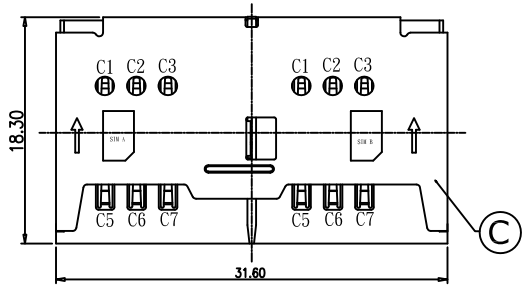
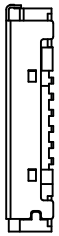
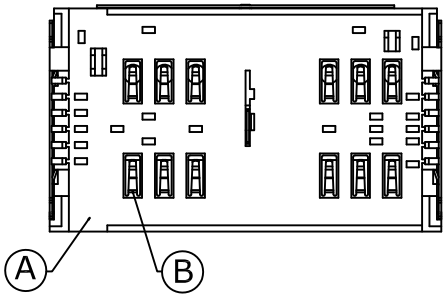
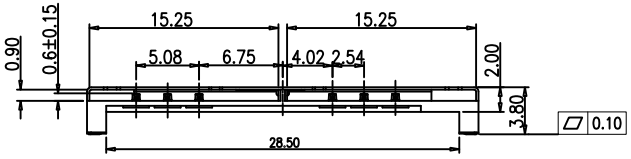
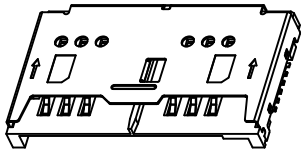
SWITCH CIRCUIT		MATERIAL AND FINISH AS BELOW					
WHEN CARD IS EJECTED	WHEN CARD IS INSERTED	A	Housing	LCP UL94V-0 Black	E		
		B	Contact	Phosphor Bronze C5191, 0.15t Contact Area:3u″ Gold,Solder Area:Tin Plating	F		
					G		
		C	Shell	SUS304 0.2t, Nickel Plating,Solder Area:Gold Flash	H		

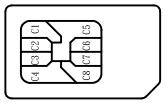




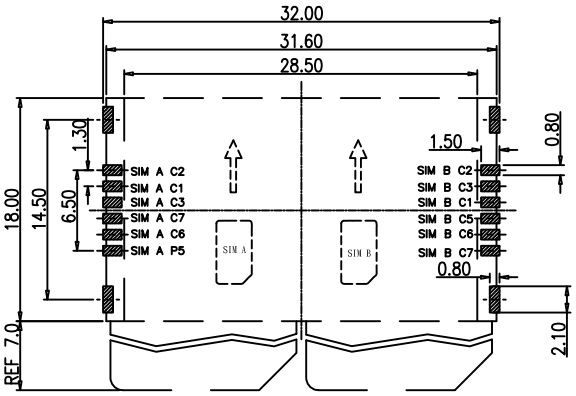








SIM Card



REFERENCE PCB LAYOUT

SPECIFICATION:

1. ELECTRICAL
1.1 Current Rating: 1.0A
1.2 Voltage Rating: 30V AC/DC
1.3 Contact Resistance: 50mΩ
1.4 Insulation Resistance: 1000MΩ
1.5 Dielectric Withstanding Voltage: 500VDC

2. MECHANICAL
2.1 Durability: 10000 Cycle

3. ENVIRONMENTAL
3.1 Operating temperature range: -40℃~+85℃
3.2 Storage temperature range: -40℃~+85℃

4. SOLDER ABILITY
4.1 Recommended IR Reflow Temperature: 260℃

VCC	RST	CLK	GND	VPP	I/O						
C1	C2	C3	C5	C6	C7						

PIN ASSIGNMENT

115L-AB380	Dual SIM Card Socket With Stand Off, Contact Area:3u″ Gold
PRODUCT NO.	DESCRIPTION

REV.	DESCRIPTION	DATE
3	Revise:	
2	Revise:	
1	Revise:	

UNLESS OTHERWISE SPECIFIED TOLERANCE

ANGLES	ANG.	±5°
LINEAR	0.	±0.3
	0.0	±0.25
	0.00	±0.20

SCALE	AS SHOWED	UNIT: mm	
DRAWN	Willis	2013/09/24	DRAWN NAME: Dual SIM Card Socket With Stand Off
CHECKED	Angel	2013/09/24	
APPROVED	Ken	2013/09/24	PRODUCT NO. 115L-AB380
SIZE A4	REV. 1.0		FILE NAME 115L-AB380_B_1

ATTEND
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